

TABLE I. Increased conductivity in selenium induced by electron bombardment.

D.c. voltage across photo-conductor	Electron accelerating voltage	Beam current, μa	Increase in current through photo-conductor, μa	Amplification factor
225	1000	0.015	0.95	63
225	2000	0.015	1.85	123

Notes

Sample resistance = $1.12 \times 10^9 \Omega$.Cross-sectional diameter of primary beam $\cong 1$ mm.

nique of preparing the photosensitive layer. Still further improvement of similar magnitude is possible by reverting to thin single crystals.

Further work on selenium as well as on other photoconductive semiconductors such as silicon, germanium, and lead sulfide is in progress.

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¹ K. G. McKay, *Tele-Tech.* 7, 72 (1948).² A. von Hippel and E. S. Rittner, *J. Chem. Phys.* 14, 372, 373, 375 (1946).³ H. Bruining, *Die Sekundär-Elektron-Emission fester Körper*, (Verlag, Julius Springer, Berlin, 1942), p. 82.⁴ See reference 2, pages 375 and 376.

Ultrasonic Observation of Twinning in Tin

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AT the suggestion of the last named writer some experiments have been performed with a view to observing the effects of individual moving dislocations. If a dislocation moves across a test specimen with a speed approaching that of sound, a displacement of the order of the lattice constant d should occur in a time of order of diameter of specimen divided by the speed of sound. This requires instruments capable of measuring displacements of about 10^{-8} cm occurring in times of 10^{-6} sec., values which lie in ranges already exploited in connection with ultrasonic delay lines.

The method of experimentation consists of pressing the metal specimen directly against a quartz crystal with a liquid seal, applying stresses which deform the metal, and observing the resulting motion imparted to the quartz. The mechanical arrangement giving the most satisfactory results is shown in Fig. 1. The tin specimen is prepared from 99.9 percent pure tin. The crystal grain size is about $\frac{1}{16}$ in. The specimen (a cone tapering from $\frac{1}{8}$ -in. to $\frac{1}{16}$ -in. diameter) presses against the quartz crystal on the right, and on the left is soldered to a silver paste baked on the tip of a long tapered glass rod. The quartz

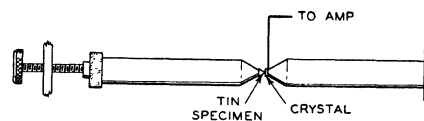


FIG. 1.

crystal (0.5 mm thick and $\frac{1}{8}$ -in. diameter) is similarly attached to the other glass rod. The two glass rods are lined up in a V block and pressure is applied by a screw through a rubber pad. During the time of observation (described below) the ultrasonic disturbance does not have time to reach the ends of the glass rods; furthermore, the transient pressure wave developed on the quartz is less than 1 percent of the applied load. As a consequence of these facts, the deformation takes place essentially at constant load. Increasing the applied load by turning the screw provokes additional transient yielding. The tapering of the rods tends to eliminate transverse reflections.

The voltage generated by the quartz crystal is amplified and split into two parts; one part actuates the trigger of a sweep circuit while the other is delayed 15 microseconds by a fused quartz delay line and then applied to vertical plates of the oscilloscope. Various electrical and mechanical tests indicate that crystal plus electrical circuits have an adequate band width for the effects studied. The sensitivity is such that a force of 1000 dynes gives $\frac{3}{8}$ -in. deflection on the oscilloscope. Because of the nature of the mechanical impedances on either side of the specimen, voltages are proportional to velocity of yield with 1000 dynes corresponding to a rate of yield of 1.6×10^{-2} cm/sec. over the $\frac{1}{16}$ -in. face of the tin specimen.

Observation of the voltage output on fast and slow sweeps shows that the noise generated consists of pulses lasting about 30 microseconds. Pantograph tracings of the photographs of two such pulses are shown in Fig. 2, together with a calibrating timing wave. Out of 15 photographs taken, 11 were similar to (a) and 4 to (b). The fine structure is not the same on any two traces, which suggests that it is characteristic of the twinning process rather than of some mechanical resonance in the specimen. The distance moved in one cycle of the fine structure is about $2A$ for (a) and about $\frac{1}{2}A$ for (b). The period of the fine structure corresponds to 3 microseconds for (a) and 1 microsecond for (b), and the time for a compression sound wave to cross the specimen is 1 microsecond.

These results are in general agreement with passage at the speed of sound of twinning dislocations from side

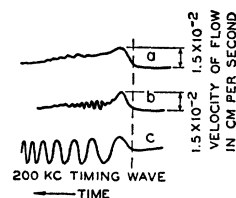


FIG. 2.